

03-30-2007



EET

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To the Director of the U.S. Patent

d documents or the new address(es) below.

1. Name of conveying party(ies):

Johannes Solhusvik

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): February 27, 2007

- ☒ Assignment ☐ Merger ☐ Change of Name
☐ Security Agreement ☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

2. Name and address of receiving party(ies)

Name: MICRON TECHNOLOGY, INC.

Internal Address:

Street Address:

8000 S. Federal Way

City: Boise

State: Idaho

Country: United States of America Zip: 83707-0006

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

☒ This document is being filed together with a new application.

A. Patent Application No.(s)

This application

B. Patent No.(s)

Additional numbers attached?

☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Thomas J. D'Amico
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6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☒ Authorized to be charged by credit card
☐ Authorized to be charged to deposit account
☐ Enclosed
☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers 1002

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b. Deposit Account Number

Authorized User Name

9. Signature:

Signature

March 13, 2007

Date

Thomas J. D'Amico - 28,371

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

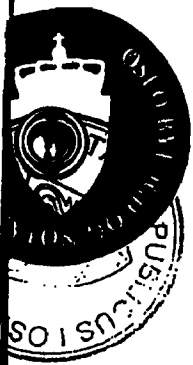
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DSMDB-2228294v01

PATENT
REEL: 019117 FRAME: 0932



ASSIGNMENT AND AGREEMENT

For value received, I, Johannes Solhusvik, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled METHOD, APPARATUS AND SYSTEM PROVIDING AN IMAGE SENSOR HAVING PIXELS WITH MULTIPLE EXPOSURES, DIODES AND GAIN READOUTS, described in an application for Letters Patent of the United States, executed by me of even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Feb-27 '07
Date

Johannes Solhusvik
Johannes Solhusvik

Witness:

Feb-27 '07
Date

Torgve Willaen

Witness:

Feb-27 '07
Date

MF Storn

The undersigned Notary Public hereby certifies that Johannes Solhusvik signed this document in my presence.

Oslo byfogdembete, 28 February 2007

Su Rong Steel
Notary Public
Su Rong Steel
førstekonsulent

